High Speed LDO Regulators, Low ESR Cap. Compatible, ON/OFF Switch

■ GENERAL DESCRIPTION

The XC6219/XC6211 series are highly accurate, low noise, CMOS LDO Voltage Regulators. Offering low output noise, high ripple rejection ratio, low dropout and very fast turn-on times, the XC6219/6211 series is ideal for today's cutting edge mobile phone.

Internally the XC6219/6211 includes a reference voltage source, error amplifiers, driver transistors, current limiters and phase compensators. The XC6219/6211's current limiters' foldback circuit also operates as a short protect for the output current limiter and. the output pin. The output voltage is set by laser trimming. Voltages are selectable in 50mV steps within a range of 0.9V to 5.0V. The XC6219/6211 series is also fully compatible with low ESR ceramic capacitors, reducing cost and improving output stability. This high level of output stability is maintained even during frequent load fluctuations, due to the excellent transient response performance and high PSRR achieved across a broad range of frequencies.

The CE function allows the output of regulator to be turned off, resulting in greatly reduced power consumption.

■ APPLICATIONS

Mobile phones

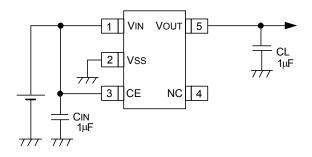
- •Cordless phones, radio communication equipment
- Portable games
- Cameras, Video cameras
- Reference voltage sources
- Battery powered equipment

FEATURES

Maximum Output Current	: 150mA (Vout<1.75V, A~D type)
	: 240mA (Vouт <u>≥</u> 1.8V, A~D type)
	: 300mA (Vouτ <u>≥</u> 1.3V, E~H type)
Dropout Voltage	: 200mV @ 100mA
Operating Voltage Range	: 2.0V ~ 6.0V
Output Voltage Range	: 0.9V ~ 5.0V (0.05V steps)
Highly Accuracy	: <u>+</u> 2% (Vouт>1.5V)
	: <u>+</u> 30mV (Vou⊤≦1.5V)
	: <u>+</u> 1% (Vout≧3.0V)
Low Power Consumption	: 25 μ A (TYP.)
Standby Current	: Less than 0.1 μ A (TYP.)
High Ripple Rejection	: 65dB @10kHz
Operating Temperature Range	: -40°C ~ 85°C
Low ESR Capacitor	: Ceramic capacitor compatible
Ultra Small Packages	: SOT-25
	: SOT-89-5 (for XC6219 only)
	: USP-6B (for XC6219 only)
Environmentally Friendly	: EU RoHS Compliant, Pb Free

■ TYPICAL APPLICATION CIRCUIT

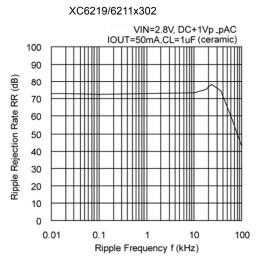
XC6219 series



SOT-25 (SOT-23-5)

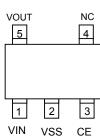
■ TYPICAL PERFORMANCE CHARACTERISTICS

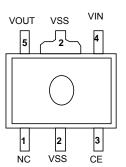
Ripple Rejection Rate



■ PIN CONFIGURATION

[XC6219 Series]



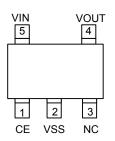


SOT-89-5

(TOP VIEW)

SOT-25 (SOT-23-5) (TOP VIEW)

[XC6211 Series]



SOT-25 (SOT-23-5) (TOP VIEW)

PIN ASSIGNMENT

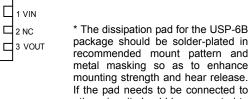
	PIN NU	JMBER			
XC6211		XC6219		PIN NAME	FUNCTIONS
SOT-25	SOT-25	SOT-89-5	USP-6B		
5	1	4	1	Vin	Power Input
2	2	2	5	Vss	Ground
1	3	3	6	CE	ON / OFF Control
3	4	1	2, 4	NC	No Connection
4	5	5	3	Vout	Output

FUNCTION

SERIES	CE	OPERATIONAL STATE
A, B, E, F Series	Н	ON
	L	OFF
	Н	OFF
C, D, G, H Series	L	ON

H=High Level

L=Low Level



USP-6B (BOTTOM VIEW)

CE 6

VSS 5

NC 4 package should be solder-plated in recommended mount pattern and metal masking so as to enhance mounting strength and hear release. If the pad needs to be connected to other pins, it should be connected to the VSS pin.

■PRODUCT CLASSIFICATION

Selection Guide

The following options for the CE pin logic and internal pull-up/down are available:

High Active + no pull-down resistor built-in (standard)

High Active + 2.0MΩ pull-down resistor built-in <between CE-Vss> (semi-custom)

Low Active + no pull-up resistor built-in (semi-custom)

Low Active + 2.0MΩ pull-up resistor built-in <between VIN-CE> (semi-custom)

Note: *With the pull-up resistor or pull-down resistor built-in types, the supply current during operation will increase by VIN / $2.0M\Omega$ (TYP.)

Ordering Information

XC6219 $(123456-7)^{(*1)}$ (Standard pin layout versions)

XC6211 (12)3(4)5)(6)-(7)^(*1)(Different pin layout version in SOT-25)

DESIGNATOR	DESCRIPTION	SYMBOL	DESCRIPTION
		A/E	High Active, pull-down resistor built in (Semi-custom)
1	CE Pin Logic	B / F	High Active, no pull-down resistor built in (Standard)
(*1)	OL I III EOgic	C / G	Low Active, pull-up resistor built in (Semi-custom)
		D/H	Low Active, no pull-up resistor built in (Semi-custom)
23	Output Voltage	09~50	e.g. ②=3, ③=0, → 3.0V
		1/2	0.1V increments, ±2% accuracy
	Output Voltage Accuracy		e.g. (3)=2, (3)=8, (4)=2 \rightarrow 2.80V, ±2%
		1 (*2)	0.1V increments, ±1% accuracy
4			e.g. (2)=3, (3)=0, (4)=1 \rightarrow 3.00V, ±1%
4		A B (*2)	0.05V increments, ±2% accuracy
			e.g. $2=2, 3=8, 4=A \rightarrow 2.85V, \pm 2\%$
			0.05V increments, ±1% accuracy
		D(2)	e.g. $(2)=3, (3)=0, (4)=B \rightarrow 3.05V, \pm 1\%$
		MR	SOT-25 (SOT-23-5)
		MR-G	SOT-25 (SOT-23-5)
56-7	Packages	PR	SOT-89-5 (for XC6219 only)
30-7	Taping Type ^(*2)	PR-G	SOT-89-5 (for XC6219 only)
		DR	USP-6B (for XC6219 only)
		DR-G	USP-6B (for XC6219 only)

NOTE :

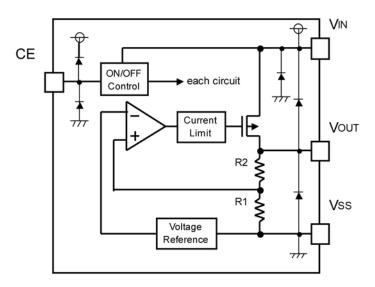
*1 : Maximum output current of XC6219/6211 E to H series is 300mA.

*2 : Output voltage of the $\pm 1\%$ accuracy product is 3.0V or more.

^(*1) The "-G" suffix indicates that the products are Halogen and Antimony free as well as being fully RoHS compliant.

(*2) The device orientation is fixed in its embossed tape pocket. For reverse orientation, please contact your local Torex sales office or representative. (Standard orientation: ⑤R-⑦, Reverse orientation: ⑤L-⑦)

■BLOCK DIAGRAM



■ABSOLUTE MAXIMUM RATINGS

				Ta=25°C
PARAME	TER	SYMBOL	RATINGS	UNITS
Input Volt	age	Vin	7.0	V
Output Cu	rrent	Ιουτ	500	mA
Output Vo	Output Voltage		Vss - 0.3 ~ Vin + 0.3	V
CE Pin Vo	CE Pin Voltage		Vss - 0.3 ~ VIN + 0.3	V
	SOT-25	Pd	250	
Power Dissipation	SOT-89		500	mW
USP-6B			100	
Operating Temperature Range		Topr	- 40 ~ + 85	C°
Storage Tempera	iture Range	Tstg	- 55 ~ + 125	°C

■ELECTRICAL CHARACTERISTICS

•XC6219/6211 series

●XC6219/6211 series Ta=25°C								
PARAMETER	SYMBOL	CC	CONDITIONS		TYP.	MAX.	UNITS	CIRCUIT
Qutput Valtage		lout=30m	A (*1, 2, 8)	x 0.98	VOUT(T)	x 1.02	v	1
Output Voltage	VOUT(E)	1% accura	1% accuracy=Vout(t)≥3.0V x		VOUI(I)	x 1.01	V	U
Maximum Output Current	Ιουτμαχ	Input cond	itions (E-1)	E-2	-	-	mA	1
Load Regulation	∆Vout	1mA≦lou	⊺≦100mA	-	15	50	mV	1
Dropout Voltage	Vdif1	IOUT=30m	A (*3, 4, 5)		E-3		mV	1)
Diopodi voltage	Vdif2	lout=100n	nA (*3, 4, 5)		E-4		mV	U
Supply Current	IDD	VCE=VIN		-	25	50	μA	2
Stand-by Current	Istby	VCE=VSS		-	0.01	0.10	μA	2
Line Degulation	_∆Vout	VOUT(T) +1	.0V≦VIN≦7.0V	-	0.01	0.20	%/V	1
Line Regulation	$ riangle VIN \cdot VOUT$	IOUT=30m	4					
Input Voltage	Vin			2.0	-	6.0	V	-
Output Voltage	∆Vout	IOUT=30m	٩		100		nnm/°C	
Temperature Characteristics		-40°C≦To	pr≦85°C	- 100	-	ppm/°C	1	
Ripple Rejection Rate	PSRR	lout=50m	۹,	-	65	-	dB	(4)
	FORM	f=10kHz	Vout(e) <u>≥</u> 1.8V		70		uв	4
Current Limiter	llim	XC6219/6	211A~D type (*7)	-	300	-	mA	(1)
Current Limiter	IIIm	XC6219/6	211 E~H type (*7)		380		IIIA	U
Short Circuit Current	Ishort			-	50	-	mA	1
CE 'High' Level Voltage	VCEH			1.60	-	Vin	V	1
CE 'Low' Level Voltage	VCEL			-	-	0.25	V	2
CE 'High' Level Current	Ісен	VCE=VIN	XC6219/11A, E	-0.10	10	5.0	μA	2
	ICER	VCE-VIN	XC6219/11B, C, D, F, G, H	-0.10	-	0.10	μΑ	Ľ
CE 'Low' Level Current	ICEL	VCE=VSS	XC6219/11D, G	-5.0	_	0.10	μA	2
		VOL-V33	XC6219/11A, B, C, E, F, H	-0.10	_	0.10	μΛ	Ľ

NOTE: * 1: VOUT(T) = Specified output voltage

* 2: VOUT(E) = Effective output voltage

(I.e. the output voltage when "VOUT(T)+1.0V" is provided at the VIN pin while maintaining a certain IOUT value.)

* 3: Vdif={VIN1^(*5)-VOUT1^(*4)}

* 4: VOUT1=A voltage equal to 98% of the output voltage whenever an amply stabilized IOUT {VOUT(T)+1.0V} is input.

* 5: VIN1=The Input Voltage when VOUT1 appears as Input Voltage is gradually decreased.

* 6: Unless otherwise stated, VIN=VOUT(T)+1.0V.
* 7: Input conditions of current limit when 0.9V≤VOUT(T)≤1.75V is VIN=VOUT(T)+2.0V

* 8: The rated value when Vout(T)≤1.5V is Vout(T)+30mV

■ ELECTRICAL CHARACTERISTICS (Continued)

Maximum Output Current, Input Voltage Chart

XC6219/6211A~D series

SYMBOL	E-1	E-2	
CONDITION, RATINGS	INPUT VOLTAGE (V)	MAX. OUTPUT	
	INFUT VOLIAGE (V)	CURRENT (mA)	
SETTING VOLTAGE (V)	Vin	IOUTMAX (MIN.)	
Vout(t)<1.75V	Vout(t)+2.0V	150	
Vout(t) <u>≥</u> 1.8V	Vout(t)+1.0V	240	

XC6219/6211E~H series

SYMBOL	E-1	E-2
CONDITION, RATINGS	INPUT VOLTAGE (V)	MAX. OUTPUT
		CURRENT (mA)
SETTING VOLTAGE (V)	Vin	IOUTMAX (MIN.)
0.90 ~ 1.05	2.5	260
1.10 ~ 1.15	2.6	270
1.20 ~ 1.25	2.7	290
1.30 ~ 1.35	2.8	
1.40 ~ 1.45	2.9	300
1.50 ~ 1.95	3.0	500
2.00 ~ 6.00	Vout(t)+1.0V	

Dropout Voltage Chart

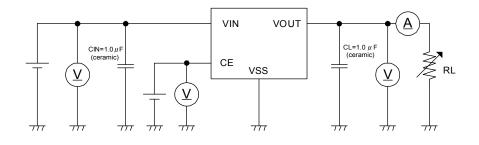
SYMBOL	E-3			E-4		
STMBOL	Vdif1			Vdif2		
PARAMETER OUTPUT VOLTAGE	MIN.	TYP.	MAX.	MIN.	TYP.	MAX.
0.9	1100	1100	1110	1100	1150	1200
1.50	500	500	510	500	550	600
1.80 ~ 1.85	200	200	210	200	300	400
1.90 ~ 1.95	100	120	150	100	280	380
2.00 ~ 2.05	-	80	120	-	240	350
2.10 ~ 2.25	-	80	120	-	240	330
2.30 ~ 2.45	-	80	120	-	240	310
2.50 ~ 2.75	-	70	100	-	220	290
2.80 ~ 2.95	-	70	100	-	220	270
3.00 ~ 3.05	-	60	90	-	200	270
3.10 ~ 3.95	-	60	90	-	200	250
4.00 ~ 4.95	-	60	80	-	180	230
5.00	-	50	70	-	160	210

* The input voltage 2.0V (MIN.) is needed to operate the IC series.

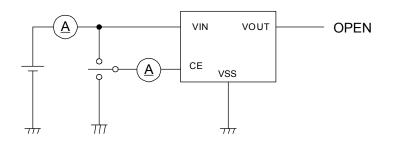
When the output voltage is less than 2.0V, 2.0V-VOUT(T) of dropout voltage is needed at minimum.

■TEST CIRCUITS

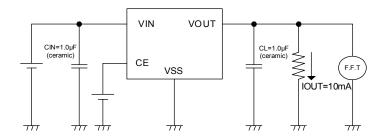
 $\text{Circuit} \ \textcircled{1}$



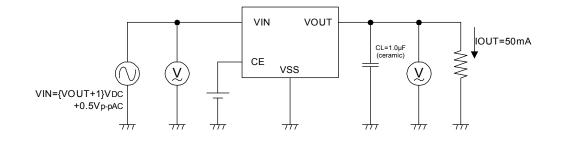
Circuit 2



Circuit ③



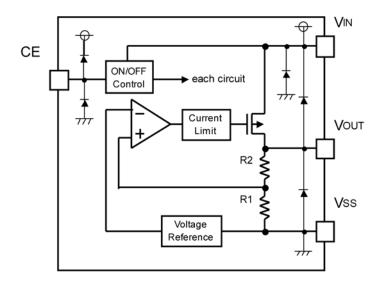
Circuit ④



■OPERATIONAL EXPLANATION

<Output Voltage Control>

The voltage divided by resistors R1 & R2 is compared with the internal reference voltage by the error amplifier. The P-channel MOSFET, which is connected to the VOUT pin, is then driven by the subsequent output signal. The output voltage at the VOUT pin is controlled and stabilized by a system of negative feedback. The current limit circuit and short protect circuit operate in relation to the level of output current. Further, the IC's internal circuitry can be shutdown via the CE pin's signal



<Low ESR Capacitors>

With the XC6219/6211 series, a stable output voltage is achievable even if used with low ESR capacitors as a phase compensation circuit is built-in. In order to ensure the effectiveness of the phase compensation, we suggest that an output capacitor (CL) is connected as close as possible to the output pin (VOUT) and the Vss pin. Please use an output capacitor with a capacitance value of at least $1.0 \,\mu$ F. Also, please connect an input capacitor (CIN) of $1.0 \,\mu$ F between the VIN pin and the Vss pin in order to ensure a stable power input.

Stable phase compensation may not be ensured if the capacitor runs out capacitance when depending on bias and temperature. In case the capacitor depends on the bias and temperature, please make sure the capacitor can ensure the actual capacitance.

<Current Limiter, Short-Circuit Protection>

The XC6219/6211 series includes a combination of a fixed current limiter circuit & a foldback circuit, which aid the operations of the current limiter and circuit protection. When the load current reaches the current limit level, the fixed current limiter circuit operates and output voltage drops. As a result of this drop in output voltage, the foldback circuit operates, output voltage drops further and output current decreases. When the output pin is shorted, a current of about 50mA flows.

<CE Pin>

The IC's internal circuitry can be shutdown via the signal from the CE pin with the XC6219/6211 series. In shutdown mode, output at the VouT pin will be pulled down to the Vss level via R1 & R2. The operational logic of the IC's CE pin is selectable (please refer to the selection guide). Note that as the standard XC6219/6211B type's regulator 1 and 2 are both ' High Active/No Pull-Down', operations will become unstable with the CE pin open. Although the CE pin is equal to an inverter input with CMOS hysteresis, with either the pull-up or pull-down options, the CE pin input current will increase when the IC is in operation. We suggest that you use this IC with either a VIN voltage or a Vss voltage input at the CE pin. If this IC is used with the correct specifications for the CE pin, the operational logic is fixed and the IC will operate normally. However, supply current may increase as a result of through current in the IC's internal circuitry.

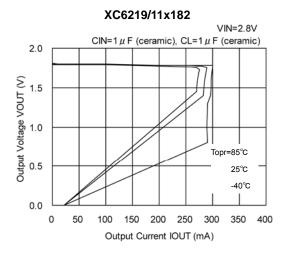
■NOTES ON USE

1. Please use this IC within the stated absolute maximum ratings. The IC is liable to malfunction should the ratings be exceeded.

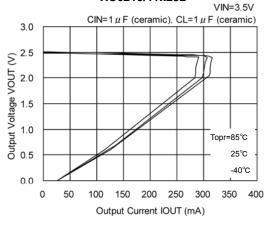
- 2. Where wiring impedance is high, operations may become unstable due to noise and/or phase lag depending on output current. Please keep the resistance low between VIN and Vss wiring in particular.
- 3. Please wire the input capacitor (CIN) and the output capacitor (CL) as close to the IC as possible.

■TYPICAL PERFORMANCE CHARACTERISTICS

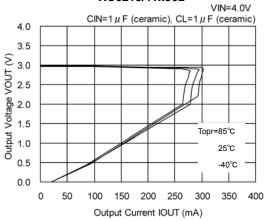
(1) Output Voltage vs. Output Current

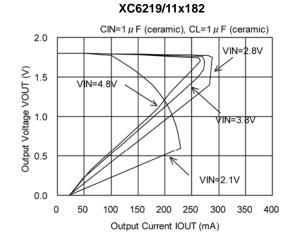


XC6219/11x252

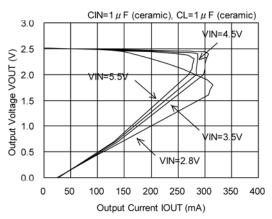




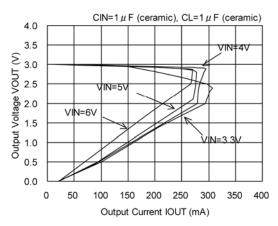




XC6219/11x252

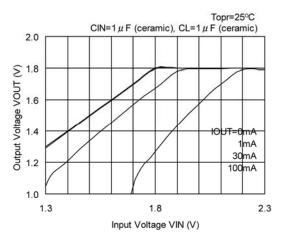


XC6219/11x302

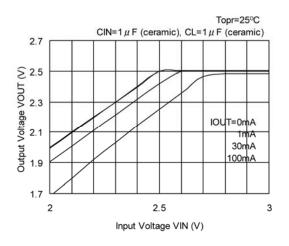


(2) Output Voltage vs. Input Voltage

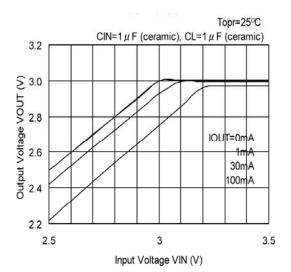
XC6219/11x182

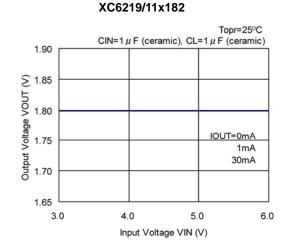


XC6219/11x252

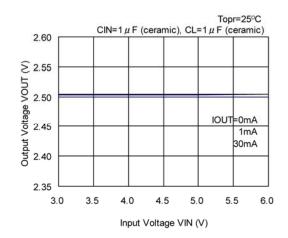


XC6219/11x302

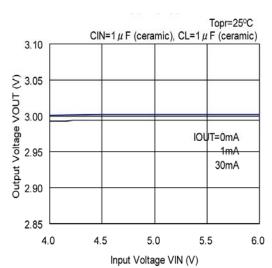




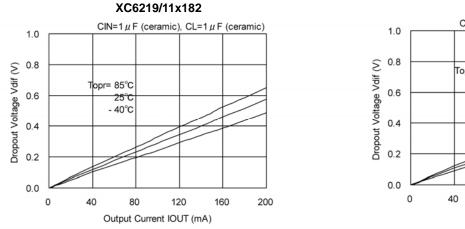
XC6219/11x252



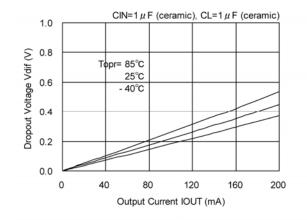
XC6219/11x302



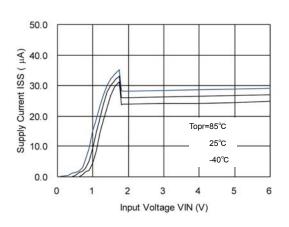
(3) Dropout Voltage vs. Output Current



XC6219/11x302

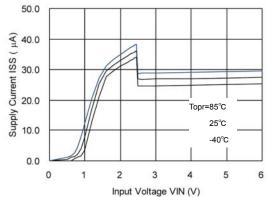


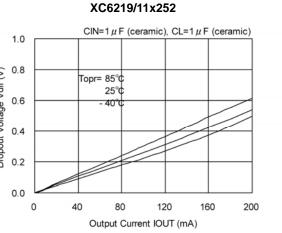
(4) Supply Current vs. Input Voltage











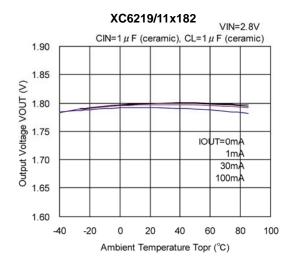
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(4) Supply Current vs. Input Voltage (Continued)

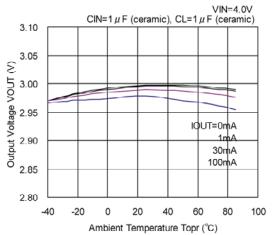
50.0 (Y 40.0 SS tubury 20.0 10.0 0.0 0 1 2 3 4 5 6 Input Voltage VIN (V)

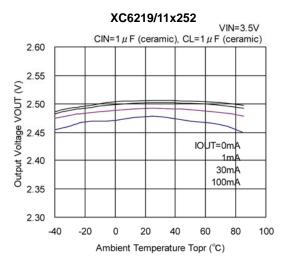
XC6219/11x302

(5) Output Voltage vs. Ambient Temperature

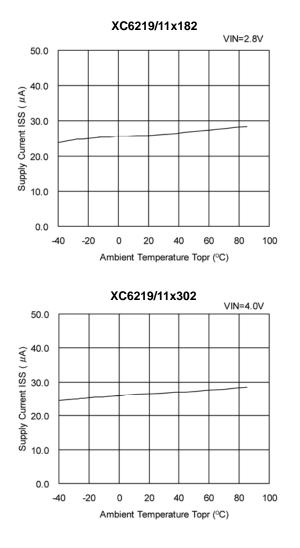


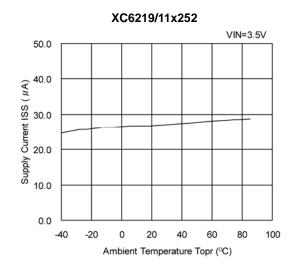




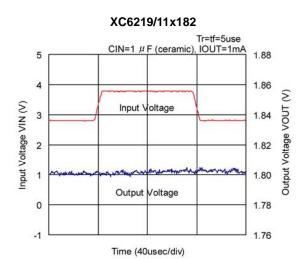


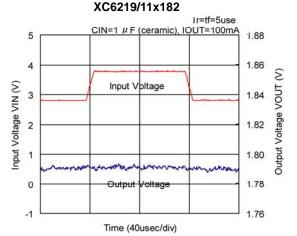
(6) Supply Current vs. Ambient Temperature



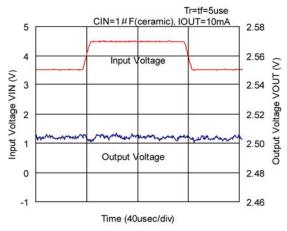


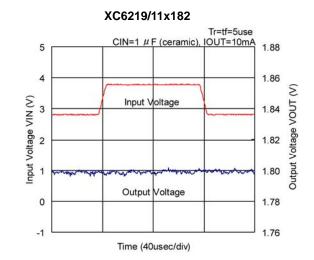
(7) Input Transient Response



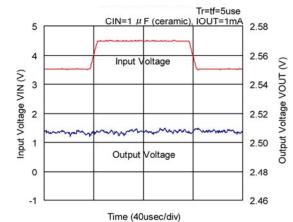


XC6219/11x252

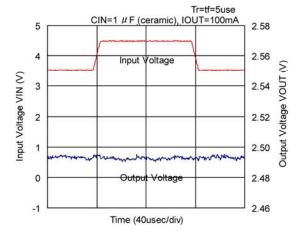




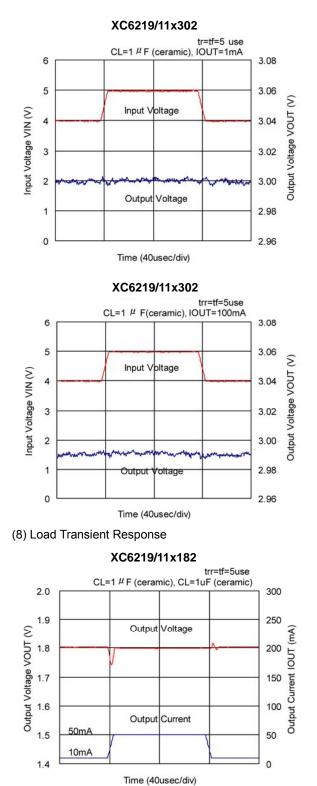
XC6219/11x252



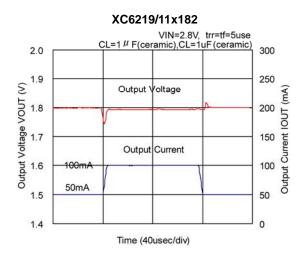
XC6219/11x252



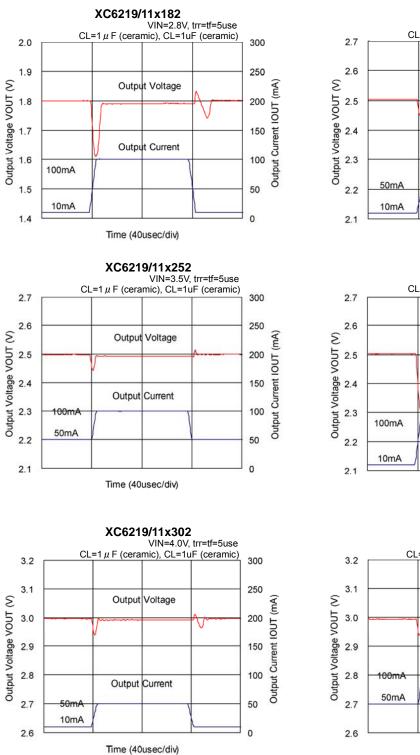
(7) Input Transient Response (Continued)

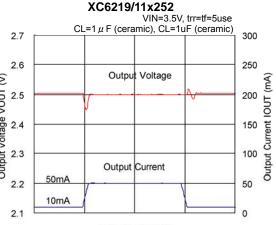


XC6219/11x302 tr=tf=5use CL=1 ^µ F (ceramic), IOUT=10mA 3.08 6 5 3.06 Output Voltage VOUT (V) Input Voltage Input Voltage VIN (V) 4 3.04 3 3.02 2 3.00 han Output Voltage 2.98 1 0 2.96 Time (40usec/div)

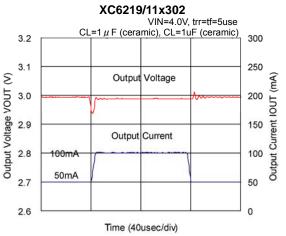


(8) Load Transient Response (Continued)

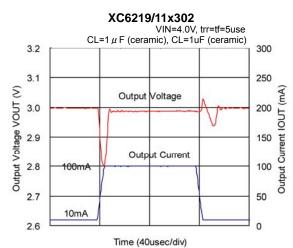




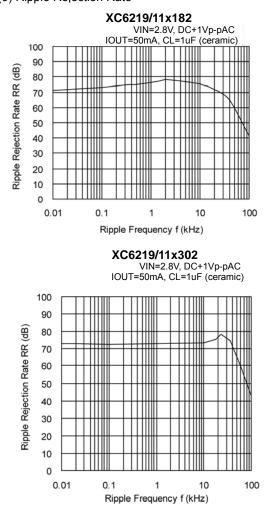
Time (40usec/div)

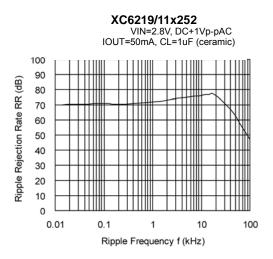


(8) Load Transient Response (Continued)



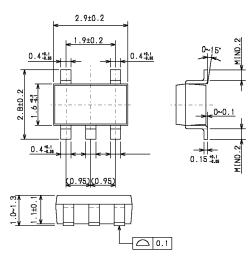
(9) Ripple Rejection Rate



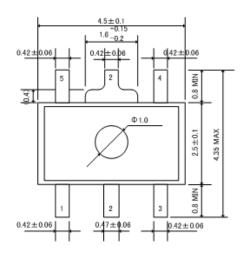


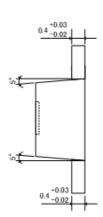
■ PACKAGING INFORMATION

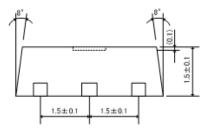




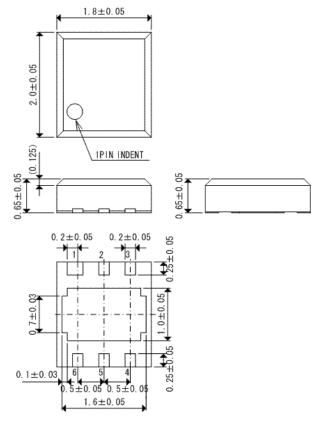
●SOT-89-5



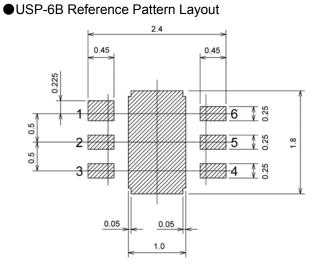




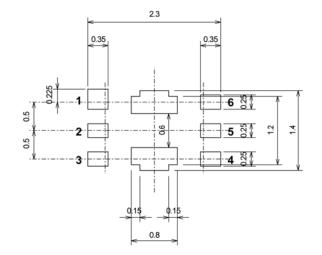
●USP-6B



■ PACKAGING INFORMATION (Continued)



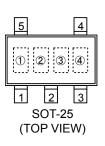
●USP-6B Reference Metal Mask Design



■MARKING RULE

[XC6219 Series]

●SOT-25, SOT-89-5



_	5	2	4
	©		©
		2 SOT-89- OP VIE	

1 represents product series

- 1	
MARK	PRODUCT SERIES
L	XC6219xxxxxx

② represents type of regulator

Vout 100mV I	VOUT 100mV INCREMENTS VOUT 50mV INCREMENTS					
Vout:0.1~3.0V	Vout:3.1~6.0V	Vout:0.15~3.05V Vout:3.15~6.05V				
V	А	E	L	XC6219Axxxxx		
Х	В	F	М	XC6219Bxxxxx		
Y	С	Н	N	XC6219Cxxxxx		
Z	D	К	Р	XC6219Dxxxxx		

3 represents output voltage

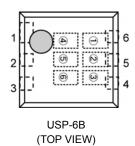
MARK OUTPUT VOLTAGE (V) MARK OUTPUT VOLTAGE (V)									
IVIANN				MARK				(v)	
0	-	3.1	-	3.15	F	1.6	4.6	1.65	4.65
1	-	3.2	-	3.25	Н	1.7	4.7	1.75	4.75
2	-	3.3	-	3.35	K	1.8	4.8	1.85	4.85
3	-	3.4	-	3.45	L	1.9	4.9	1.95	4.95
4	-	3.5	-	3.55	М	2.0	5.0	2.05	-
5	-	3.6	-	3.65	Ν	2.1	-	2.15	-
6	-	3.7	-	3.75	Р	2.2	-	2.25	-
7	-	3.8	-	3.85	R	2.3	-	2.35	-
8	0.9	3.9	0.95	3.95	S	2.4	-	2.45	-
9	1.0	4.0	1.05	4.05	Т	2.5	-	2.55	-
A	1.1	4.1	1.15	4.15	U	2.6	-	2.65	-
В	1.2	4.2	1.25	4.25	V	2.7	-	2.75	-
С	1.3	4.3	1.35	4.35	Х	2.8	-	2.85	-
D	1.4	4.4	1.45	4.45	Y	2.9	-	2.95	-
E	1.5	4.5	1.55	4.55	Z	3.0	-	3.05	-

④ represents production lot number

0 to 9, A to Z reverse character of 0 to 9, A to Z repeated (G, I, J, O, Q, W excluded)

■MARKING RULE (Continued)

●USP-6B



①② represents product series

MA	RK		
1	2	PRODUCT SERIES	
1	9	XC6219xxxxDx	

③ represents type of regulator

MARK	TYPE	PRODUCT SERIES
А	High Active, pull-down resistor built-in (semi-custom)	XC6219AxxxMx
В	High Active, no pull-down resistor built-in (semi-custom)	XC6219BxxxMx
С	Low Active, pull-up resistor built-in (semi-custom)	XC6219CxxxMx
D	Low Active, no pull-up resistor built-in (semi-custom)	XC6219DxxxMx

④ represents product series

MARK	VOLTAGE (V)	PRODUCT SERIES		
3	3.X	XC6219x3xxDx		
5	5.X	XC6219x5xxDx		

⑤ represents output voltage

MARK	VOLTAGE PRODUCT SERIES		SYMBOL	VOLTAGE	PRODUCT SERIES
0	X.0	XC6219xx0xDx	А	X.05	XC6219xx0ADx
1	X.1	XC6219xx1xDx	В	X.15	XC6219xx1ADx
2	X.2	XC6219xx2xDx	С	X.25	XC6219xx2ADx
3	X.3	XC6219xx3xDx	D	X.35	XC6219xx3ADx
4	X.4	XC6219xx4xDx	Ш	X.45	XC6219xx4ADx
5	X.5	XC6219xx5xDx	F	X.55	XC6219xx5ADx
6	X.6	XC6219xx6xDx	Н	X.65	XC6219xx6ADx
7	X.7	XC6219xx7xDx	К	X.75	XC6219xx7ADx
8	X.8	XC6219xx8xDx	L	X.85	XC6219xx8ADx
9	X.9	XC6219xx9xDx	М	X.95	XC6219xx9ADx

⑥ represents production lot number

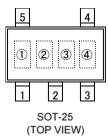
0 to 9, A to Z repeated (G, I, J, O, Q, W excluded)

* No character inversion used.

■MARKING RULE (Continued)

[XC6211 Series]

●SOT-25



① represents product series

[MARK	PRODUCT SERIES
	Α	XC6211xxxxMx

② represents type of regulator

Vout 100mV I	PRODUCT SERIES			
Vout:0.1~3.0V	Vout:3.1~6.0V	Vout:0.15~3.05V	Vout:3.15~6.05V	
V	A	E	L	XC6211AxxxMx
Х	В	F	М	XC6211BxxxMx
Y	С	Н	Ν	XC6211CxxxMx
Z	D	К	Р	XC6211DxxxMx

③ represents output voltage

MARK	OUTPUT VOLTAGE (V) MARK OUTPUT VOLTAGE (V)								
WARK				MARK				(v)	
0	-	3.1	-	3.15	F	1.6	4.6	1.65	4.65
1	-	3.2	-	3.25	Н	1.7	4.7	1.75	4.75
2	-	3.3	-	3.35	K	1.8	4.8	1.85	4.85
3	-	3.4	-	3.45	L	1.9	4.9	1.95	4.95
4	-	3.5	-	3.55	М	2.0	5.0	2.05	5.05
5	-	3.6	-	3.65	Ν	2.1	5.1	2.15	5.15
6	-	3.7	-	3.75	Р	2.2	5.2	2.25	5.25
7	-	3.8	-	3.85	R	2.3	5.3	2.35	5.35
8	-	3.9	-	3.95	S	2.4	5.4	2.45	5.45
9	-	4.0	-	4.05	Т	2.5	5.5	2.55	5.55
А	-	4.1	-	4.15	U	2.6	5.6	2.65	5.65
В	-	4.2	-	4.25	V	2.7	5.7	2.75	5.75
С	-	4.3	-	4.35	Х	2.8	5.8	2.85	5.85
D	-	4.4	-	4.45	Y	2.9	5.9	2.95	5.95
E	-	4.5	-	4.55	Z	3.0	6.0	3.05	6.05

④ represents production lot number

0 to 9, A to Z reverse character of 0 to 9, A to Z repeated (G, I, J, O, Q, W excluded)

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